



#### **6A LOW VF BRIDGE RECTIFIER**

## **Product Summary**

V <sub>RRM</sub> (V)	I <sub>F</sub> (A)	V <sub>F</sub> Max (V) @I <sub>F</sub> = 3A	I <sub>R</sub> Max (μA)
600	6	0.90	5

### **Mechanical Data**

- Package: GBP
- Package Material: Plastic Material, UL Flammability Classification 94V-0. (No Br. Sb, Cl)
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ©3
- · Polarity Indicator: Symbol Molded on Body
- · Weight: 1.33 grams (Approximate)



### **Features**

- Glass Passivated Die Construction
- Low-Forward Voltage Drop
- Ideal for Printed Circuit Board
- Reliable Low-Cost Construction Utilizing Molded Plastic
- UL Recognized File # E95060
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <a href="https://www.diodes.com/quality/product-definitions/">https://www.diodes.com/quality/product-definitions/</a>



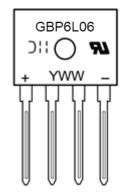
## **Ordering Information** (Note 4)

Part Number	Paakaga	Packing	
Fait Number	Package	Qty.	Carrier
GBP6L06-TU	GBP	35	Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



GBP6L06 = Product Type Marking Code

| | = Manufacturer's Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 3 = 2023)

WW = Week Code (01 to 53)



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Value	Unit
Maximum Repetitive Peak Reverse Voltage	VRRM	600	V
Maximum Average Rectified Output Current With Heatsink  @ T <sub>J</sub> = +150°C Without Heatsink	l <sub>F(AV)</sub>	6.0 2.3	А
Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	IFSM	135	Α
Peak Forward Surge Current 1.0ms Single Half Sine Wave Superimposed on Rated Load		270	Α
I <sup>2</sup> t Rating for Fusing (t = 8.3ms)		75.6	A <sup>2</sup> s
Operating Temperature Range	TJ	-55 to +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

## **Electrical Characteristics** (@TA = +25°C, unless otherwise specified.)

Characteristic	Test Co	nditions	Symbol	Min	Тур	Max	Unit
Breakdown Voltage	$I_R = 5\mu A, T_J = +2$	25°C	V <sub>B</sub>	600	_		V
Forward Voltage	IF = 3A, T <sub>J</sub> = +25	5°C	VF		0.84	0.9	V
Leakage Current	V <sub>R</sub> = 600V	T <sub>J</sub> = +25°C T <sub>J</sub> = +125°C	I <sub>R</sub>	_	_	5.0 500	μΑ
Typical Junction Capacitance (Note 5)	_		Ст		75		pF

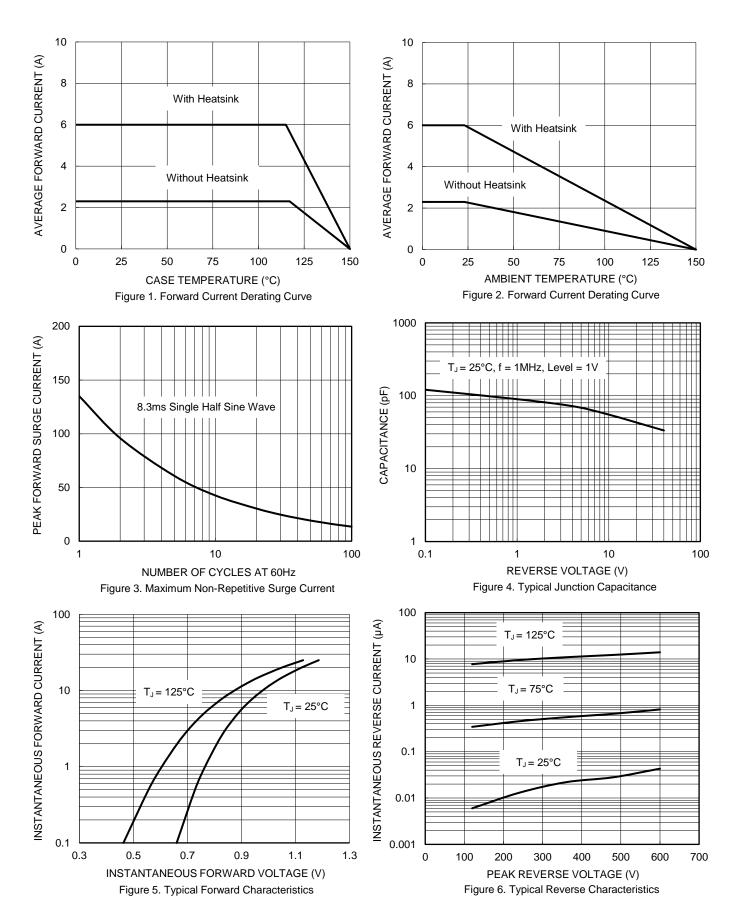
## **Thermal Characteristics**

Characteristic	Symbol	Тур	Unit
Typical Thermal Resistance (Without Heatsink)	Rejc Rejl Reja	12 18 45	°C/W
Typical Thermal Resistance (Notes 6 & 7)	Rejc Rejl Reja	5 7 16	°C/W

Notes:

- 5. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
  6. Thermal resistance junction to case, lead and ambient in accordance with JESD-51.
- 7. Device mounted on 100mm x 100mm x 1.6mm Cu plate heatsink.



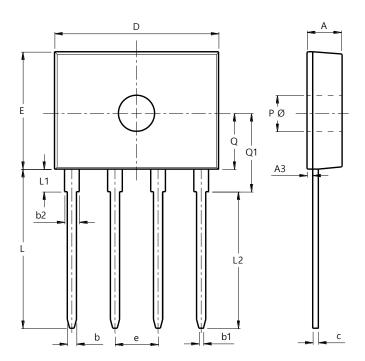




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### GBP



GBP					
Dim	Min	Max	TYP		
Α	2.90	3.30	3.10		
A3	0.30	0.70	0.50		
b	0.76	0.86	0.81		
b1	0.35	0.45	0.40		
b2	1.20	1.40	1.30		
С	0.40	0.60	0.50		
D	14.20	14.70	14.50		
Е	10.10	10.70	10.40		
е	3.71	3.91	3.81		
L	13.80	14.40	14.10		
L1	1.80	2.20	2.00		
L2	12.10 REF				
PØ	3.20 REF				
Q	4.65	5.25 4.9			
Q1	6.65	7.25	6.95		
All Dimensions in mm					



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